



Spec No. :DS30-2011-0159 Effective Date: 01/21/2020

Revision: B

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4



LED DISPLAY

LTS-2806CKR-P

| Rev | <u>Description</u> | <u>By</u> | <u>Date</u> | | |
|--|--|-----------|-------------|--|--|
| 01 | Preliminary Spec. | Reo Lin | 01/31/2013 | | |
| | | | | | |
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| | | | | | |
| | | | | | |
| Above data for PD and Customer tracking only | | | | | |
| - | NPPR Received and Upload on System | Reo Lin | 06/08/2013 | | |
| A | Revised error for PCB thickness from 0.6 mm to 0.8 mm in | Reo Lin | 03/21/2016 | | |
| Λ | page 3 | IVEO EIII | 05/21/2010 | | |
| В | Update Packing spec. in page 9 | Reo Lin | 01/10/2020 | | |
| | | | | | |

Part No.: LTS-2806CKR-P



1. Description

The LTS-2806CKR-P is a 0.28 inch (7.0 mm) digit height single digit SMD display. This device uses AS-AlInGap Super Red LED chips (AlInGap epi on GaAs substrate). The display has gray face and white segments.

1.1 Features

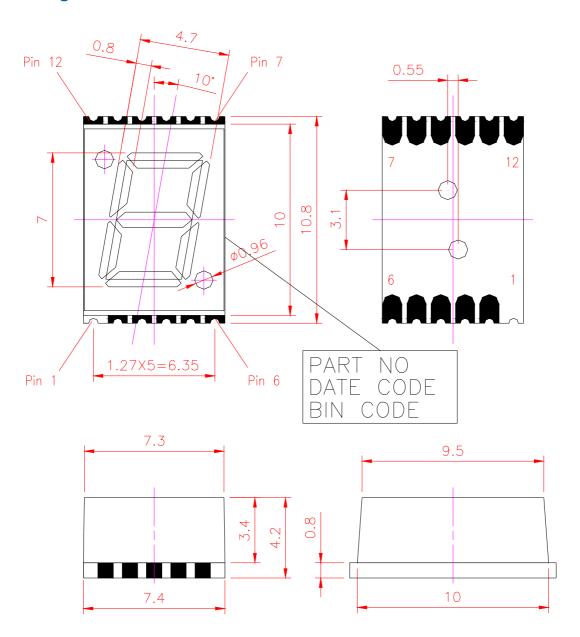
- 0.28 inch (7.0 mm) DIGIT HEIGHT
- CONTINUOUS UNIFORM SEGMENTS
- LOW POWER REQUIREMENT
- EXCELLENT CHARACTERS APPEARANCE
- HIGH BRIGHTNESS & HIGH CONTRAST
- WIDE VIEWING ANGLE
- SOLID STATE RELIABILITY
- CATEGORIZED FOR LUMINOUS INTENSITY.
- LEAD-FREE PACKAGE(ACCORDING TO ROHS)

1.2 Device

| Part No | Description | | |
|-------------------|--------------|--|--|
| AllnGaP Super Red | Common Anode | | |
| LTS-2806CKR-P | | | |



2. Package Dimensions

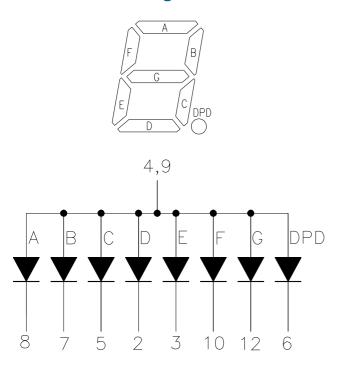


Notes:

- 1. All dimensions are in millimeters. Tolerances are ±0.25 mm (0.01") unless otherwise noted
- 2. Foreign material on segment ≤10mil
- 3. Ink contamination (surface) \leq 20mils
- 4. Bubble in segment \leq 10mil
- 5. Bending \leq 1% of reflector length
- 6. Plastic pin's burr max is 0.1 mm



3. Internal Circuit Diagram



4. Pin Connection

| No | Connection |
|----|---------------|
| 1 | NO CONNECTION |
| 2 | CATHODE D |
| 3 | CATHODE E |
| 4 | COMMON ANODE |
| 5 | CATHODE C |
| 6 | CATHODE DP |
| 7 | CATHODE B |
| 8 | CATHODE A |
| 9 | COMMON ANODE |
| 10 | CATHODE F |
| 11 | NO CONNECTION |
| 12 | CATHODE G |



5. Rating and Characteristics

5.1. Absolute Maximum Rating at Ta=25℃

| Parameter | Maximum Rating | Unit | |
|---|----------------|------|--|
| Power Dissipation Per Segment | 70 | mW | |
| Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1ms Pulse Width) | 90 | mA | |
| Continuous Forward Current Per Segment | 25 | mA | |
| Derating Linear From 25℃ Per Segment | 0.28 | mA/℃ | |
| Operating Temperature Range | -35℃ to +105℃ | | |
| Storage Temperature Range | -35℃ to +105℃ | | |
| | • | | |

Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260°C

5.2.Electrical / Optical Characteristics at Ta=25℃

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Test Condition |
|--|--------|------|------|------|------|----------------|
| Average Lumin and Intensity Day Comment | IV | 201 | 650 | | μcd | IF=1mA |
| Average Luminous Intensity Per Segment | | | 8250 | | μcd | IF=10mA |
| Peak Emission Wavelength | λр | | 639 | | nm | IF=20mA |
| Spectral Line Half-Width | Δλ | | 20 | | nm | IF=20mA |
| Dominant Wavelength | λd | | 631 | | nm | IF=20mA |
| Forward Voltage Per Chip | VF | | 2.05 | 2.6 | V | IF=20mA |
| Reverse Current Per Segment ⁽²⁾ | IR | | | 100 | μΑ | VR=5V |
| Luminous Intensity Matching Ratio (Similar Light Area) | IV-m | | | 2:1 | | IF=1mA |

Notes:

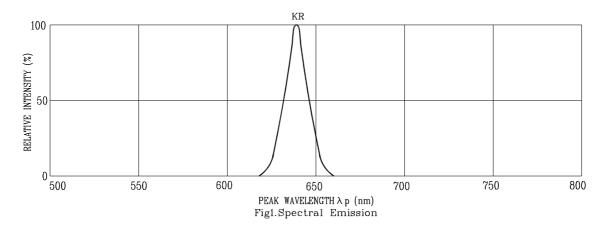
- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclariage) eye-response curve
- 2. Reverse voltage is only for IR test. It cannot continue to operate at this situation
- 3. Cross talk specification \leq 2.5%

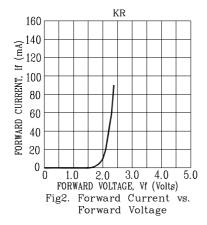
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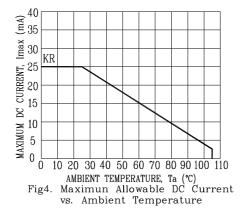


5.3. Typical Electrical / Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)







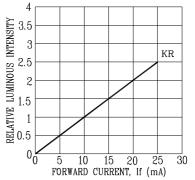
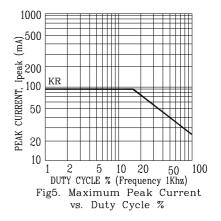


Fig3. Relative Luminous Intensity vs. DC Forward Current



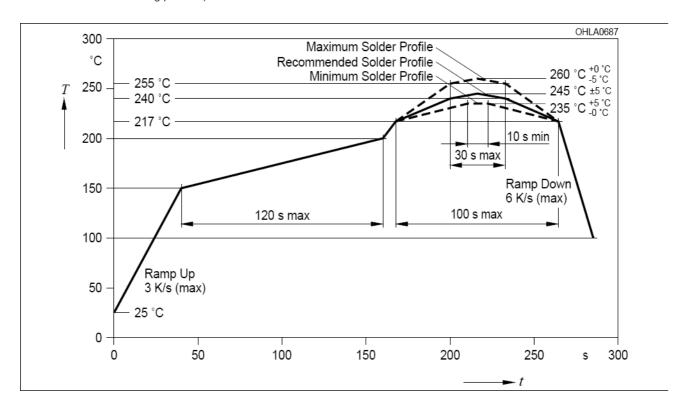
NOTE: KR=AlInGaP SUPER RED

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6. SMT SOLDERING INSTRUCTION

(Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process)



Notes:

1. Recommended soldering condition

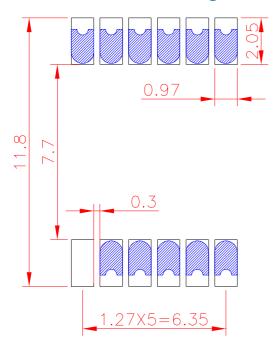
| Reflow Soldering (Two times only) | | Soldering Iron (One time only) | | |
|-----------------------------------|--------------|--------------------------------|------------|--|
| Pre-heat: | 120~150°C. | Temperature | 300°C Max. | |
| Pre-heat time: | 120sec. Max. | Soldering time | 3sec. Max. | |
| Peak temperature: | 260℃ Max. | | | |
| Soldering time: | 5sec. Max. | | | |

2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

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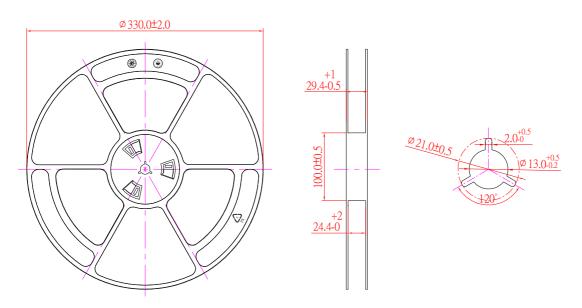


7. Recommended Soldering Pattern



8. Packing Specification

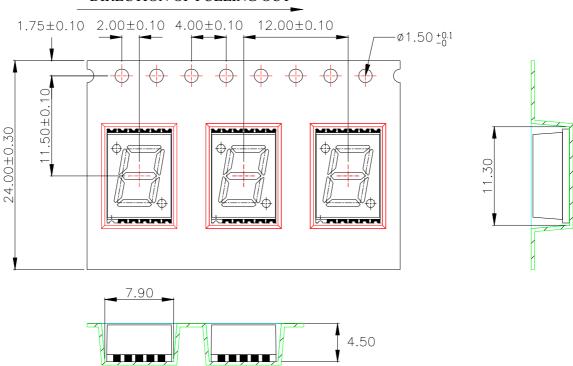
8.1. Packing Reel Dimensions





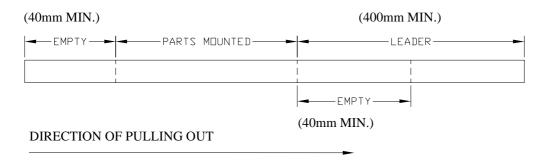
8.2. Packing Carrier Dimensions

DIRECTION OF PULLING OUT



- 1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
- Carrier camber is within 1 mm in 250 mm.
 Material: Black Conductive Polystyrene Alloy.
- 4. All dimensions meet EIA-481 requirements.
- 5. Thickness: 0.40 ± 0.05 mm.
- 6. Packing length per 22" reel: 38.5 Meters.7. Component load per 13" reel: 1000 pcs.
- 8. Minimum packing quantity is 250 pcs for remainders

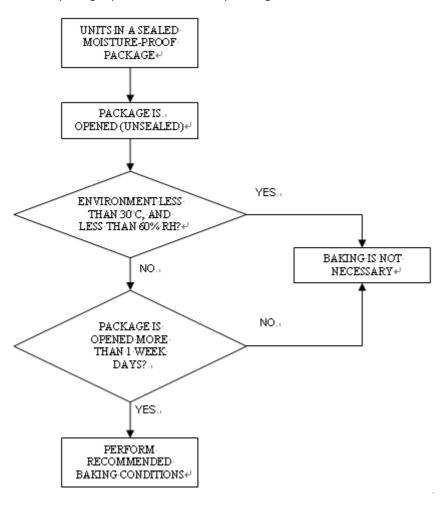
8.3. Trailer part / Leader part





9. Moisture Proof Packing

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30° C or less and 6 0% RH or less. Once the package opened, moisture absorption begins.



If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts. Baking should only be done once

| Package | Temperature | Time | |
|----------|-------------|----------|--|
| In Reel | 60°C | ≥48hours | |
| In Bulk | 100°C | ≥4hours | |
| III DUIK | 125°C | ≥2hours | |

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